

L Number	Hits	Search Text	DB	Time stamp
1	582	(438/660).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/27 15:49
2	162	(438/663).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/27 15:49
-	25	"single wafer" same (rtp or rapid adj thermal) and convection	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/05 10:22
-	31	thermal and susceptor and gas adj ring and quartz	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/05 09:57
-	271	(rtp or rapid adj thermal) and convection and wafer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/05 11:49
-	2	("5879459").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/05 10:26
-	14	("4533410" "4533820" "4689247" "4828224" "4836138" "4846102" "4976996" "4993360" "5077875" "5119760" "5194401" "5336327" "5749974" "5788447").PN.	USPAT	2003/06/05 10:23
-	20	5879459.URPN.	USPAT	2003/06/05 10:24
-	0	(21/5).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/05 10:27
-	0	(21/6).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/05 10:27
-	0	(21/7).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/05 10:27
-	46	(rtp or rapid adj thermal) and convection and wafer and rotate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/05 11:50
-	14	5837555.URPN.	USPAT	2003/10/25 13:03
-	7	("3713900" "4312681" "4365588" "4794217" "4978567" "5011794" "5308161").PN.	USPAT	2003/10/25 13:05
-	8	4365588.URPN.	USPAT	2003/10/25 13:06